Load Termination
(place as close as possible to the DAC)

Source Termination
(place as close as possible to the DAC)

NOTES:
1) DNI = DO NOT INSTALL
Place as close to the DAC as possible
NOTE 1:
Place as close to the modulator as possible
NOTE 1:
Place as close to the modulator as possible
Ext Input Ref Clock to LMK

Present Indicator

***DCLKP/N are topside traces
DCLKP/N traces on the bottom side of board are 2" longer than DCLK-P/N traces on top side.
To use Step Down Converter only (DNI LDO's U12):
Install R145
DNI R146, R147
Change R148 to 820K
Change R151 to 180K
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